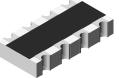


CRA04P

Vishay

Thick Film, Resistor Array



The CRA04P thick film resistor array is constructed on a high grade ceramic body with concave terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts and assembly costs.

FEATURES

- · Concave terminal array with square corners
- Wide ohmic range: 1R0 to 1M0
- 8 terminal package with isolated resistors
- Lead (Pb)-free solder contacts on NI barrier layer
- · Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- · Compatible with "Restriction of the use of Hazardous Substances" (RoHS) directive 2002/95/EC (issue 2004)

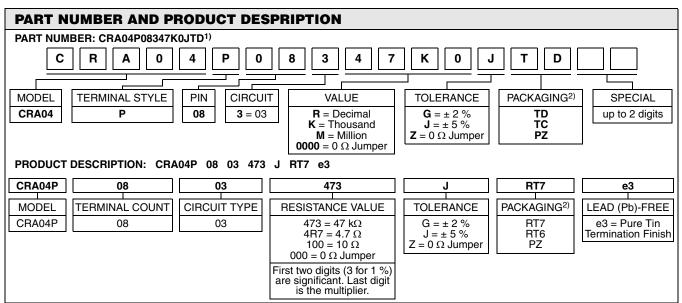
STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	CIRCUIT	POWER RATING P _{70 °C} W	LIMITING ELEMENT VOLTAGE MAX V≅	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	E-SERIES	
CRA04P	03	0.063	50	± 100	± 2	10R - 1M0	24	
				± 200	± 5	1R0 - 1M0	24	
		Zero-Ohm-Resisto	r: $R_{\text{max}} = 50 \text{ m}\Omega$, $I_{\text{max}} = 1$	IA				

TECHNICAL SPECIFICATIONS					
PARAMETER	UNIT	CRA04P			
Rated Dissipation at 70 °C ²⁾	W per element	0.063			
Limiting Element Voltage ¹⁾	V≅	50			
Insulation Voltage (1 min)	V _{dc/ac peak}	100			
Category Temperature Range	O°	- 55/+ 125 (+ 155)			
Insulation Resistance	Ω	> 10 ⁹			

Notes

1. Rated voltage: $\sqrt{P \times R}$

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded. 2.



Notes

Preferred way for ordering products is by use of the PART NUMBER.
Please refer to the table PACKAGING, see next page.

CRA04P

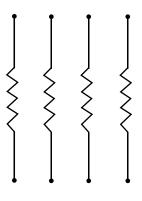
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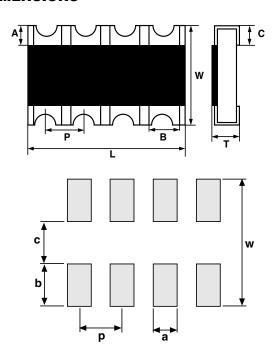
PACKAGING							
		DIAMETER	РІТСН	PIECES/REEL	PACKING CODE		
MODEL	TAPE WIDTH				PAPER TAPE		
					PART NUMBER	PRODUCT DESCRIPTION	
		180 mm/7"	2 mm	10 000	TD	RT7	
CRA04P	8 mm	330 mm/13"	2 mm	20 000	тс	RT6	
		330 mm/13"	2 mm	50 000	PZ	PZ	

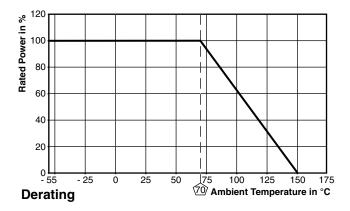
CIRCUIT

03 Circuit









PIN NO#	DIMENSIONS [in millimeters]							
	L	Α	в	С	Р _{NOM}	т	w	
8	2.00	0.20	0.32	0.25	0.50	0.35	1.00	
TOL	± 0.10	± 0.10	± 0.10	± 0.10	-	± 0.10	± 0.10	

SOLDER PAD DIMENSIONS [in millimeters]						
	с	w	р	а	b	
WAVE	0.5	1.5	0.5	0.32	0.5	



CRA04P

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EN 60115-1					
TEST	CONDITIONS OF TEST	REQUIREMENTS PERMISSIBLE CHANGE (∆ <i>R/R</i>) ¹⁾ STABILITY CLASS 2 OR BETTER			
(clause)					
	stability for product types:	10 o to 1 Mo	1.0 to 1 MO		
	CRA04P	10 Ω to 1 M Ω	1 Ω to 1 MΩ		
Resistance (4.5)	-	±2%	± 5 %		
Temperature coefficient (4.8.4.2)	20/- 55/20 °C and 20/125/20 °C	± 100 ppm/K	± 200 ppm/K		
Overload (4.13)	$U = 2.5 \times (P_{70} \times R)^{1/2}$ \$\le 2 \times U_{max}; 0.5 \text{ s}	± (0.5 % <i>R</i> + 0.05 Ω)			
Solderability (4.17.5) ²⁾	Aging 4 h at 155 °C, dryheat Solder bath method; 235 °C; 2 s Visual examination	Good tinning (≥ 95 % covered) no visible damage			
Resistance to soldering heat (4.18.2)	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.5 % <i>R</i> + 0.05 Ω)			
Rapid change of temperature (4.19)	30 min. at LCT = - 55 °C; 30 min. at UCT = 125 °C; 5 cycles	± (0.5 % <i>R</i> + 0.05 Ω)			
Damp heat, steady state (4.24)	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (2 % <i>R</i> + 0.1 Ω)			
Climatic sequence (4.23)	16 h at UCT = 125 °C; 1 cycle at 55 °C; 2 h at LCT = - 55 °C; 1 h/1 kPa at 15 °C to 35 °C; 5 cycles at 55 °C $U = (P_{70} \times R)^{1/2}$ $U = U_{max}$; whichever is less severe	± (2 % <i>R</i> + 0.1 Ω)			
Endurance at 70 °C (4.25.1)	$U = (P_{70} \times R)^{1/2}$ $U = U_{max}$; whichever is less severe 1.5 h on; 0.5 h off; 70 °C; 1000 h	± (2 % <i>R</i> + 0.1 Ω)			
Extended endurance (4.25.1.8)	Duration extended to 8000 hours	± (4 % <i>R</i> + 0.1 Ω)			
Endurance at upper category temperature (4.25.3)	UCT = 125 °C; 1000 h	± (2 % <i>R</i> + 0.1 Ω)			

Notes

1. Figures are given for a single element.

2. Solderability is specified for 2 years after production or requalification. Permitted storage time is 20 years.

APPLICABLE SPECIFICATIONS

• EN 60115-1	Generic Specification
• EN 140400	Sectional Specification
• EN 140401-802	Detail Specification
• IEC 60068-2-X	Variety of environmental test procedures
• EIA 481	Packaging of SMD components
• LIA 401	Fackaging of Sivid components



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